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November 2013

# FDP045N10A / FDI045N10A N-Channel PowerTrench® MOSFET

**100 V, 164 A, 4.5 m**Ω

#### **Features**

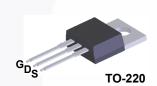
- $R_{DS(on)}$  = 3.8 m $\Omega$  ( Typ.) @  $V_{GS}$  = 10 V,  $I_D$  = 100 A
- · Fast Switching Speed
- Low Gate Charge, Q<sub>G</sub> = 54 nC (Typ.)
- High Performance Trench Technology for Extremely Low  $R_{DS(on)}$
- · High Power and Current Handling Capability
- · RoHS Compliant

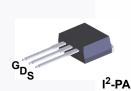
## **Description**

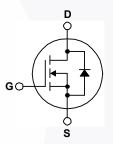
This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench® process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

## **Applications**

- Synchronous Rectification for ATX / Server / Telecom PSU
- · Battery Protection Circuit
- · Motor drives and Uninterruptible Power Supplies
- · Micro Solar Inverter







## **MOSFET Maximum Ratings** T<sub>C</sub> = 25°C unless otherwise noted.

Symbol		Parameter			
$V_{DSS}$	Drain to Source Voltage	100	V		
$V_{GSS}$	Gate to Source Voltage		±20	V	
		- Continuous (T <sub>C</sub> = 25°C, Silicon Limited)	164*	Α	
$I_D$	Drain Current	- Continuous (T <sub>C</sub> = 100°C, Silicon LImited)	116		
		- Continuous (T <sub>C</sub> = 25°C, Package Limited)	120		
I <sub>DM</sub>	Drain Current	- Pulsed (Note 1)	656	Α	
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	637	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.0	V/ns	
В	Power Dissipation	$(T_C = 25^{\circ}C)$	263	W	
$P_{D}$	Fower Dissipation	- Derate Above 25°C	1.75	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperate	-55 to +175	°C		
TL	Maximum Lead Temperature for S	Soldering, 1/8" from Case for 5 Seconds	300	οС	

<sup>\*</sup>Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 120A.

#### **Thermal Characteristics**

Symbol	Parameter	FDP045N10A_F102 FDI045N10A_F102	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.57	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max. 62.5		C/VV

## **Package Marking and Ordering Information**

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FDP045N10A_F102	FDP045N10A	TO-220	Tube	N/A	N/A	50 units
FDI045N10A_F102	FDI045N10A	I <sup>2</sup> -PAK	Tube	N/A	N/A	50 units

## **Electrical Characteristics** T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	cteristics					
$BV_{DSS}$	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	100	-	-	V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 μA, Referenced to 25°C	-	0.07	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 80 \text{ V}, T_{C} = 150^{\circ}\text{C}$	-	-	1 500	μΑ
I <sub>GSS</sub>	Gate to Body Leakage Current	V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0 V	-	-	±100	nA

#### On Characteristics

V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2.0	-	4.0	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 100 A	-	3.8	4.5	mΩ
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 100 A	-	132	ı	S

### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V - 50 V V - 0 V	-	3960	5270	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V —— f = 1 MHz	-	925	1230	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1 1011 12	-	34	-	pF
C <sub>oss</sub> (er)	Engry Releted Output Capacitance	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V	-	1520	-	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10V	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 50 V,	-	54	74	nC
$Q_{gs}$	Gate to Source Gate Charge	I <sub>D</sub> = 100 A		17	-	nC
Q <sub>gs2</sub>	Gate Charge Threshold to Plateau		-	8	-	nC
$Q_{gd}$	Gate to Drain "Miller" Charge	(Note 4)	-	13	-	nC
ESR	Equivalent Series Resistance (G-S)	f = 1 MHz	-	1.9	-	Ω

## **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time		-/	23	56	ns
t <sub>r</sub>		$V_{DD} = 50 \text{ V}, I_{D} = 100 \text{ A},$	-	26	62	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_G = 4.7 \Omega$	/ -	50	110	ns
t <sub>f</sub>	Turn-Off Fall Time	(Note 4)	-	15	40	ns

#### **Drain-Source Diode Characteristics**

IS	Maximum Continuous Drain to Source Diode Forward Current			-	164*	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current			-	656	Α
$V_{SD}$	Drain to Source Diode Forward Voltage V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 100 A		-	-	1.3	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, V <sub>DD</sub> = 50 V, I <sub>SD</sub> = 100 A,	-	75	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$dI_F/dt = 100 A/\mu s$		120	-	nC

#### Notes

- 1. Repetitive rating: pulse-width limited by maximum junction temperature.
- 2. L = 3 mH, I $_{AS}$  = 20.6 A, R $_{G}$  = 25  $\Omega$ , starting T $_{J}$  = 25°C.
- 3.  $I_{SD} \le 100$  A, di/dt  $\le 200$  A/ $\mu$ s,  $V_{DD} \le BV_{DSS}$ , starting  $T_J$  = 25°C.
- 4. Essentially independent of operating temperature typical characteristics.

## **Typical Performance Characteristics**

Figure 1. On-Region Characteristics

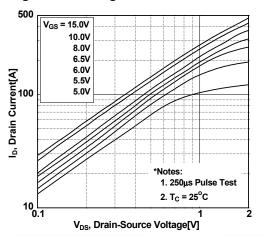


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

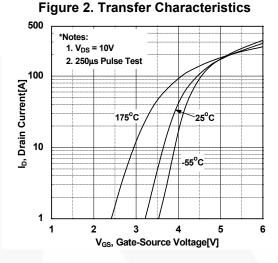


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

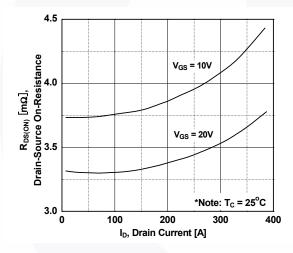
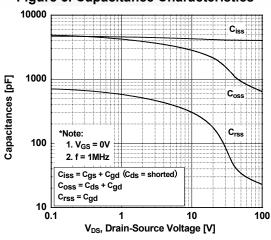


Figure 5. Capacitance Characteristics



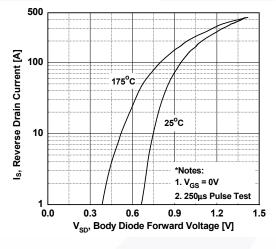
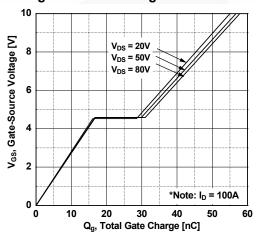


Figure 6. Gate Charge Characteristics



## **Typical Performance Characteristics** (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

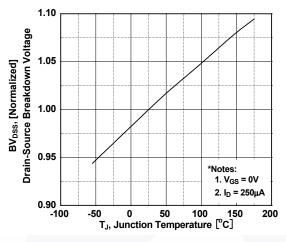


Figure 8. On-Resistance Variation vs. Temperature

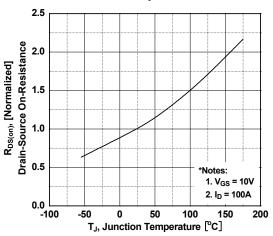


Figure 9. Maximum Safe Operating Area

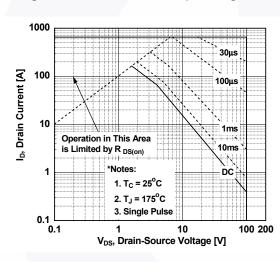


Figure 10. Maximum Drain Current vs. Case Temperature

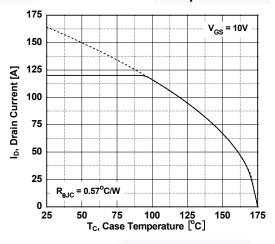


Figure 11. Eoss vs. Drain to Sourece Voltage

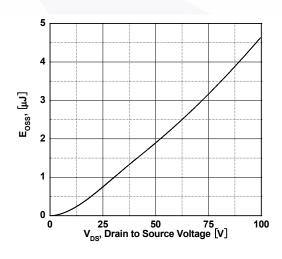
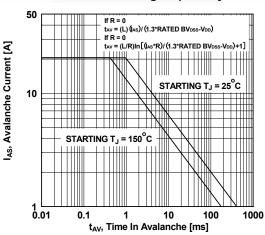
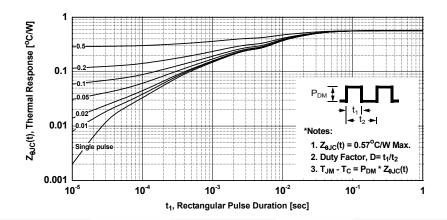


Figure 12. Unclamped Inductive Switching Capability



## **Typical Performance Characteristics** (Continued)

Figure 13. Transient Thermal Response Curve



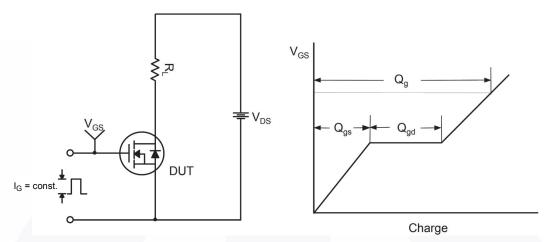


Figure 14. Gate Charge Test Circuit & Waveform

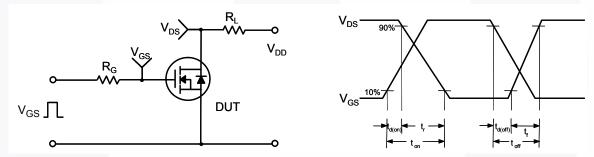


Figure 15. Resistive Switching Test Circuit & Waveforms

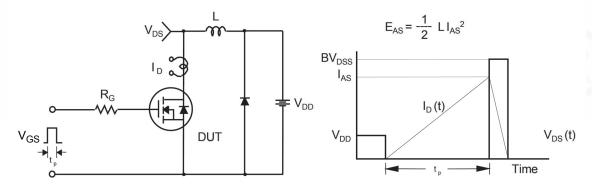


Figure 16. Unclamped Inductive Switching Test Circuit & Waveforms

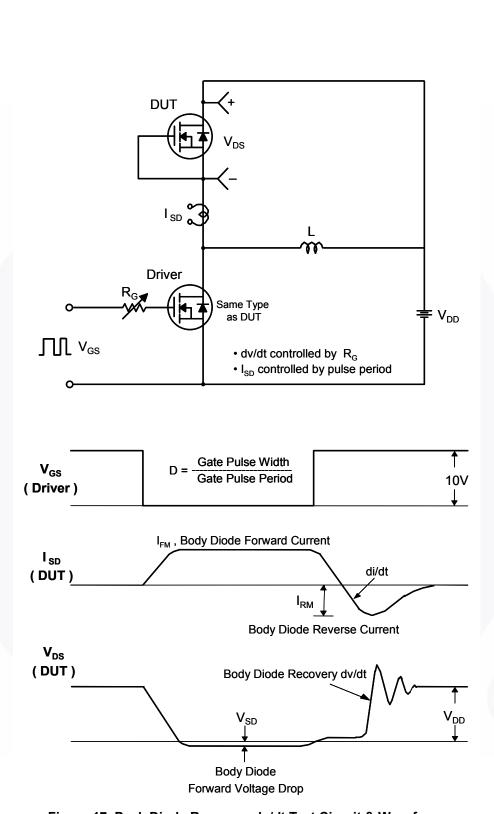


Figure 17. Peak Diode Recovery dv/dt Test Circuit & Waveforms

#### **Mechanical Dimensions**

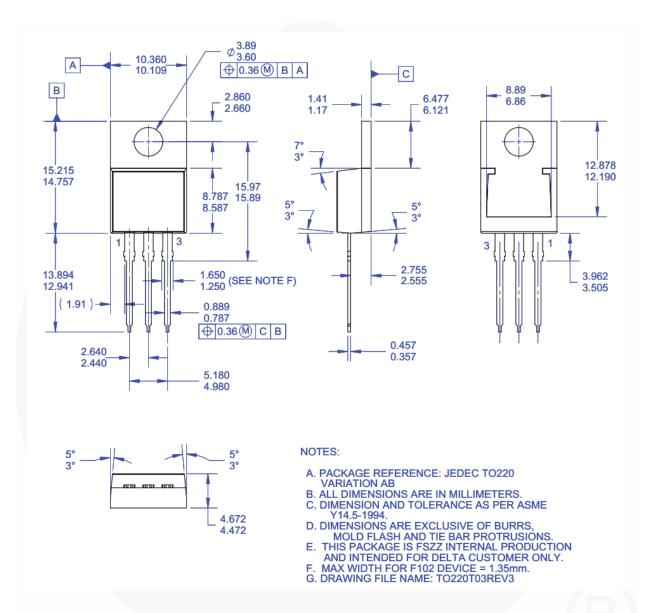


Figure 18. TO-220, Molded, 3-Lead, Jedec Variation AB (Delta)

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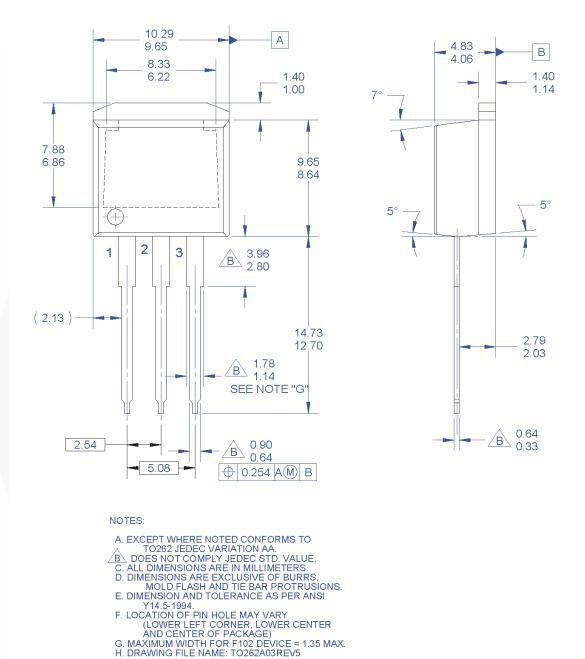


Figure 19. TO262 (I<sup>2</sup>PAK), Molded, 3-Lead, Jedec Variation AA

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